EAST Search History

EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	62	257/E23.031.ccls.	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/04/19 09:49
S1	1	"20040065945".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 20:37
S2	3289	257/666.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 20:40
S3	2778	257/723.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 20:40
S4	0	lead adj on adj chip	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 20:41
S5	701	lead-on-chip	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 20:41
S6	385	lead-on-chip	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/04/18 20:41
S7	1757	257/666.ccls.	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/04/18 20:41
S8	151	S5 and lead$1frame and (adhesive or tape) and (molding or epoxy) and (chip or die) and (first or second) and wire	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 20:43
S9	601	S2 and (leadframe or lead$1frame) and (adhesive or tape) and (molding or epoxy) and (chip or die) and (first or second) and wire	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 20:44
S10	5	joh.in. near2 cheol.in.	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 20:45
S11	19	chung.in. near2 qwan.in.	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 20:45
S12	23	S10 or S11	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 20:45

S13	2007	"23" and (leadframe or lead$1frame) and (adhesive or tape) and (molding or epoxy) and (chip or die) and (first or second) and wire	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 20:45
S14	1	S12 and (leadframe or lead$1frame) and (adhesive or tape) and (molding or epoxy) and (chip or die) and (first or second) and wire	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 20:45
S15	1	"20030011052".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 23:58
S16	1	"5834831".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2010/04/18 23:59

4/19/10 9:49:43 AM